

**LINEAR TECHNOLOGY MATERIALS DECLARATION**

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(Engineering Calculation)

SSOP

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**TOTAL MASS (g) : 0.151063**

COMPONENT MATERIAL	VENDOR/ INDUSTRY NAMES	CONSTITUENT NAME	CAS NUMBER	CONSTITUENT MASS (g)	CONSTITUENT (PPM) OF MATERIAL	CONSTITUENT (PPM) OF TOTAL PKG.		
Active Device	Linear Technology	Silicon (Si)	7440-21-3	0.004891	1000000	32377.2949219		
Die Coat	Dow Corning	Silicone	69430-27-9	0.000000	0	0		
Lead Frame	Cu	Copper (Cu)	7440-50-8	0.058880	975000	389772.0625		
		Iron (Fe)	7439-89-6	0.001449	24000	9592.04589844		
		Phosphorus (P)	7723-14-0	0.000018	300	119.155860901		
		Zinc (Zn)	7440-66-6	0.000042	700	278.030334473		
		Nickel (Ni)	7440-02-0	0.000000	0	0		
		Silicon (Si)	7440-21-3	0.000000	0	0		
		Magnesium (Mg)	7439-95-4	0.000000	0	0		
		Tin (Sn)	7440-31-5	0.000000	0	0		
<b>Lead Frame Total:</b>				<b>0.060389</b>	<b>1000000</b>	<b>399761.28125</b>		
Plating	PMI	Exter. Plating Pb	7439-92-1	0.000000	0	0		
		Exter. Plating Sn	7440-31-5	0.002831	1000000	18738.1386719		
		<b>External Plating Total:</b>				<b>0.002831</b>	<b>1000000</b>	<b>18738.1386719</b>
		Inter. Plating Ni	7440-02-0	0.000000	0	0		
		Inter. Plating Ag	7440-22-4	0.000483	1000000	3197.34887695		
<b>Internal Plating Total:</b>				<b>0.000483</b>	<b>1000000</b>	<b>3197.34887695</b>		
Die Attach	ELECTRICALLY CONDUCTIVE ADHESIVE	Silver (Ag)	7440-22-4	0.001276	750000	8446.82617188		
		Tin (Sn)	7440-31-5	0.000000	0	0		
		Lead (Pb)	7439-92-1	0.000000	0	0		
		Silica (SiO2)	60676-86-0	0.000000	0	0		
		Indium (In)	7440-74-6	0.000000	0	0		
		Metal Oxide		0.000000	0	0		
		Antimony (Sb)	7440-36-0	0.000000	0	0		
		Resin (EP)		0.000425	250000	2813.40234375		
<b>Die Attach Total:</b>				<b>0.001701</b>	<b>1000000</b>	<b>11260.2294922</b>		
Encapsulation	MULTI-AROMATIC RESIN Br/Sb FREE	Resin (EP)		0.008259	103000	54672.6796875		
		Bromine (Br)	40039-93-8	0.000000	0	0		
		Silica (SiO2)	60676-86-0	0.071761	895000	475041.3125		
		Antimony Trioxide (Sb2O3)	1309-64-4	0.000000	0	0		
		Metal Hydroxide		0.000000	0	0		
		Carbon Black (C)	1333-86-4	0.000160	2000	1059.16308594		
		<b>Encapsulation Total:</b>				<b>0.080180</b>	<b>1000000</b>	<b>530773.125</b>
Bond Wire Estimated	AFW/TANAKA/ Kn	Gold (Au)	7440-57-5	0.000588	1000000	3892.42480469		
					<b>TOTAL MASS (g) :</b>	<b>0.151063</b>		